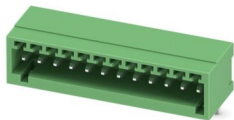


# MC 0,5/12-G-2,5 - PCB header

1881545

<https://www.phoenixcontact.com/us/products/1881545>

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PCB headers, nominal cross section: 0.5 mm<sup>2</sup>, color: green, nominal current: 4 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 12, number of rows: 1, number of positions: 12, number of connections: 12, product range: MC 0,5/..-G, pitch: 2.5 mm, mounting: Wave soldering, conductor/PCB connection direction: 0 °, pin layout: Linear pinning, solder pin [P]: 3.8 mm, number of solder pins per potential: 1, plug-in system: COMBICON FK-MC 0,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: packed in cardboard

## Your advantages

- Well-known mounting principle allows worldwide use

## Commercial data

Item number	1881545
Packing unit	50 pc
Minimum order quantity	50 pc
Sales key	AA01
Product key	AAASAA
GTIN	4017918156787
Weight per piece (including packing)	2.65 g
Weight per piece (excluding packing)	2.384 g
Customs tariff number	85366930
Country of origin	GR

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## Technical data

### Product properties

Product type	PCB headers
Product family	MC 0,5/...-G
Product line	COMBICON Connectors XS
Type	Standard
Number of positions	12
Pitch	2.5 mm
Number of connections	12
Number of rows	1
Number of potentials	12
Mounting type	without
Pin layout	Linear pinning
Solder pins per potential	1

### Electrical properties

#### Properties

Nominal current $I_N$	4 A
Nominal voltage $U_N$	160 V
Contact resistance	2 mΩ
Rated voltage (III/3)	80 V
Rated surge voltage (III/3)	1.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

### Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1 μm - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface soldering area (middle layer)	Nickel (1 μm - 3 μm Ni)

# MC 0,5/12-G-2,5 - PCB header

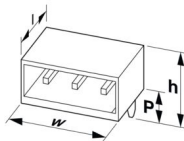
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## Material data - housing

Color (Housing)	green (6021)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

## Dimensions

Dimensional drawing	
Pitch	2.5 mm
Width [w]	31.9 mm
Height [h]	11.9 mm
Length [l]	10.1 mm
Installed height	8.1 mm
Solder pin length [P]	3.8 mm
Pin dimensions	0.8 x 0.8 mm

## PCB design

Hole diameter	1.2 mm
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## Mechanical tests

### Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

### Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

### Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

### Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

# MC 0,5/12-G-2,5 - PCB header



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## Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

## Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	6 N

## Electrical tests

### Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	12

### Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

### Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	80 V
Rated surge voltage (III/3)	1.5 kV
minimum clearance value - non-homogenous field (III/3)	0.8 mm
minimum creepage distance (III/3)	1.7 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

## Environmental and real-life conditions

### Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R <sub>1</sub>	2 mΩ
Contact resistance R <sub>2</sub>	2.2 mΩ

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Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

## Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm <sup>3</sup> SO <sub>2</sub> on 300 dm <sup>3</sup> /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

## Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

## Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

## Packaging specifications

Type of packaging	packed in cardboard
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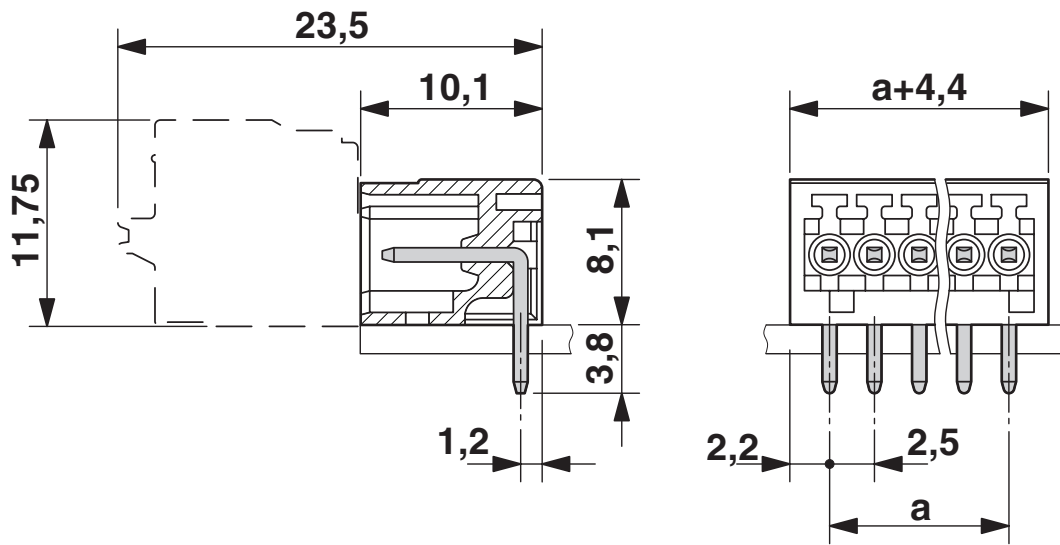
# MC 0,5/12-G-2,5 - PCB header

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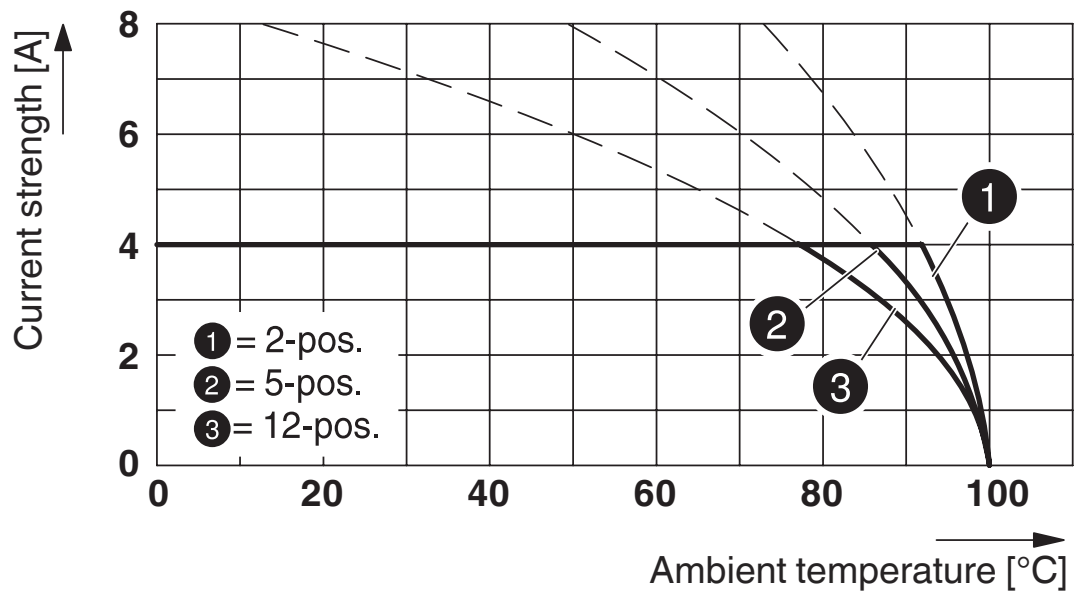
<https://www.phoenixcontact.com/us/products/1881545>

## Drawings

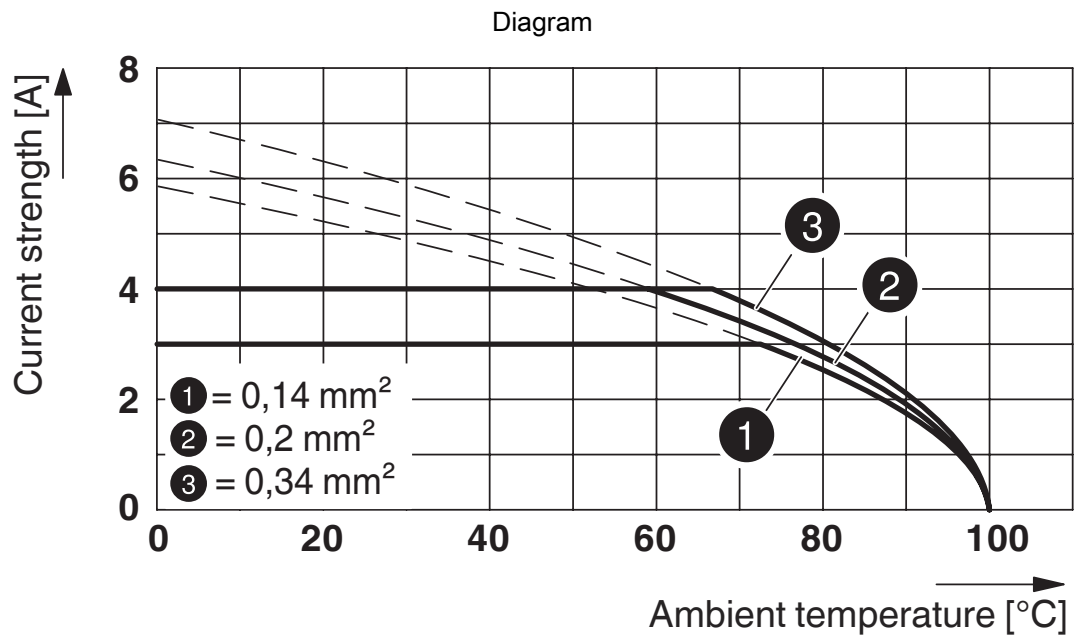
Dimensional drawing



Diagram



Type: FK-MC 0,5/...-ST-2,5 with MC 0,5/...-G-2,5



Type: FK-MC 0,5/...-ST-2,5 with MC 0,5/...-G-2,5

Drilling plan/solder pad geometry



# MC 0,5/12-G-2,5 - PCB header



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## Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1881545>

 <b>cULus Recognized</b> Approval ID: E60425-19990913				
	Nominal voltage $U_N$	Nominal current $I_N$	Cross section AWG	Cross section $\text{mm}^2$
B	125 V	4 A	-	-

 <b>VDE report with production monitoring</b> Approval ID: 40013394				
	Nominal voltage $U_N$	Nominal current $I_N$	Cross section AWG	Cross section $\text{mm}^2$
keine	80 V	4 A	-	-

# MC 0,5/12-G-2,5 - PCB header



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## Classifications

### ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

### ETIM

ETIM 10.0	EC002637
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### UNSPSC

UNSPSC 21.0	39121400
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## Environmental product compliance

### EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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### China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

### EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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### EF3.1 Climate Change

CO2e kg	0.025 kg CO2e
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